				20240221006.1 PCN Dat			te:	February 21, 2024			
Title:Qualification of RFAB using qualified Process Technology, Die Revision and additional Assembly site/BOM options for select devices											
				Change Management <b>Dept:</b>			Dept:			Quality Services	
Proposed Date:	Proposed 1 <sup>st</sup> Ship Date: May 21, 2			)24	Sample requests accepted until:						
*Sample	requests r	eceiv	ved af	ter	March 22, 2	024	will not	be	sup	ported.	
Change T	ype:										
Assen	nbly Site			$\boxtimes$	Design				Wa	afer Bump Material	
Assen	nbly Proces	S			Data Sheet				Wa	afer Bump Process	
Assembly Materials					Part number	Part number change			Wafer Fab Site		
Mechanical Specification			on		Test Site			$\boxtimes$	Wafer Fab Material		
Packing/Shipping/Labeling					Test Process 🛛 🕅			Wa	Wafer Fab Process		
	PCN Details										

## **Description of Change:**

Texas Instruments is pleased to announce the qualification of its RFAB fabrication facility as an additional Wafer Fab option in addition to a BOM option for the devices listed below.

Cı	urrent Fab Sit	e	Additional Fab Site				
Current Fab Site	Irrent Fab Process Site		Additional Fab Site	Process	Wafer Diameter		
SFAB	JI1	Diameter 150 mm					
SFAB	OI	150 mm			200 mm		
SFAB	IMPC60-80	150 mm	RFAB	LBC7	300 mm		
DL-LIN	LBC3S	200 mm					

The die was also changed as a result of the process change.

Construction differences are as follows:

# Group 1 BOM Table (RFAB/Process migration/BOM Option plus CDAT as additional Assembly site):

	TI Malaysia	CDAT		
Mount Compund	4205846 or 4147858	4207123		
Mold Compound	4208625 or 4211880	4222198		

# Group 2 BOM Table (RFAB/Process migration/BOM Option plus TI Mexico as additional Assembly site):

	TI Malaysia	TI Mexico
Bond wire composition,	Cu or Au, 0.96	Cu, 0.96 mil
diameter	mil	
Mount Compund	4042500 or	4147858
	4147858	
Mold Compound	4042503 or	4211880
	4211880	

Qual details are provided in the Qual Data Section.

## **Reason for Change:**

These changes are part of our multiyear plan to transition products from our 150-millimeter and 200-millimeter factories to newer, more efficient manufacturing processes and technologies, underscoring our commitment to product longevity and supply continuity. **Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):** 

### None

## Impact on Environmental Ratings:

Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.

RoHS	REACH	Green Status	IEC 62474
🛛 🛛 No Change	🛛 No Change	🛛 No Change	🛛 🖂 No Change
Changes to produ	ct identification result	ing from this PCN:	

### Fab Site Information:

Chip Site	Chip Site Origin Code (20L)	Chip Site Country Code (21L)	Chip Site City
SH-BIP-1	SHE	USA	Sherman
DL-LIN	DLN	USA	Dallas
RFAB	RFB	USA	Richardson

## **Die Rev:**

Current	New
Die Rev [2P]	Die Rev [2P]
L, N,-	-

## **Assembly Site Information:**

Assembly Site	Assembly Site Origin (22L)	Assembly Country Code (23L)	Assembly City	
MLA	MLA	MYS	Kuala Lumpur	
CDAT	CDA	CHN	Chengdu	
FMX	MEX	MEX	Aguascalientes	

Sample product shipping label (not actual product label):

TEXAS INSTRUMENTS MADE IN: Malaysia 2DC: 2Q:	(1P) SN74LS07NSR (Q) 2000 (D) 0336
MSL 2 /260C/1 YEAR SEAL DT MSL 1 /235C/UNLIM 03/29/04	
LBL: 5A (L)T0:1750	(2P) REV: (V) 0033317 (2P) REV: (V) 0033317 (20L) CSO: SHE (21L) CCO:USA (22L) ASO: MLA (23L) ACO: MYS

## **Product Affected:**

Group 1 Device list (RFAB/Process migration/BOM Option plus CDAT as additional Assembly site)

SN65C1167ERGYR SN65C1168ERGYR

# Group 2 Device list (RFAB/Process migration/BOM Option plus TI Mexico as additional Assembly site)

SN75ALS1177N SN75ALS1178N

Group 3 Device list (RFAB/Process migration only)									
SN65C1167ENSR	SN65C1168EPWRG4	SN751178N	SN75C1167DBR						
SN65C1167EPWR	SN751177N	SN751178NSR	SN75C1168DBR						
SN65C1168ENSR	SN751177NSR	SN75ALS1177NSR							
SN65C1168EPWR	SN751177NSRE4	SN75ALS1178NSR							

For alternate parts with similar or improved performance, please visit the product page on  $\underline{\text{TI.com}}$ 

#### **Qualification Results**

#### Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN751177N</u>	Qual Device: <u>SN751178N</u>	QBS Reference (Package): <u>TLC339IN</u>	QBS Reference (Process): <u>TPS51217DSCR</u>	QBS Reference (Product): <u>SN751178NSR</u>	QBS Reference (Product): <u>SN751177NSR</u>	QBS Reference (Product): <u>SN65C1167ENSR</u>
UHAST	A3	Autoclave	121C/15psig	96 Hours	-	-	3/231/0	-	-	-	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	3/231/0	-	-	-	-
HTSL	A6	High Temperature Storage Life	170C	420 Hours	-	-	3/231/0	-	-	-	-
HTOL	B1	Life Test	135C	635 Hours	-	-	-	3/231/0	-	-	-
SD	C3	PB-Free Solderability	8 Hours Steam Age	-	-	-	3/66/0	-	-	-	-
ESD	E2	ESD CDM	-	1000 Volts	-	-	-	-	1/3/0	-	1/3/0
ESD	E2	ESD CDM	-	250 Volts	1/3/0	1/3/0	-	-	-	1/3/0	-
ESD	E2	ESD HBM	-	1000 Volts		-	-	-	1/3/0	1/3/0	-
ESD	E2	ESD HBM (Bus Pins)	-	15000 Volts	-	-	-	-	-	-	1/3/0

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN751177N</u>	Qual Device: <u>SN751178N</u>	QBS Reference (Package): <u>TLC339IN</u>	QBS Reference (Process): <u>TPS51217DSCR</u>	QBS Reference (Product): <u>SN751178NSR</u>	QBS Reference (Product): <u>SN751177NSR</u>	QBS Reference (Product): <u>SN65C1167ENSR</u>
ESD	E2	ESD HBM	-	4000 Volts	-	-	-	-	-	-	1/3/0
LU	E4	Latch-Up	Per JESD78	-	-	-	-	-	1/3/0	1/3/0	-
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	1/30/0	-	-	1/30/0	1/30/0	-

QBS: Qual By Similarity

Qual Device SN751177N is qualified at NOT CLASSIFIED NOT CLASSIFIED

Qual Device SN751178N is qualified at NOT CLASSIFIED NOT CLASSIFIED

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

• The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

• The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

• The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2206-028

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: SN65C1168EPWR	Qual Device: SN65C1168ENSR	Qual Device: SN75C1167DBR	Qual Device: SN65C1167EPWR	Qual Device: <u>SN75C1168DBR</u>	QBS Reference (Process): TPS51217DSCR	QBS Reference (Package): TPS2074DB	QBS Reference (Package): <u>SN74LVC8T245NSR</u>	QBS Reference (Package): <u>TCA6416PW</u>	QBS Reference (Product): <u>SN65C1167ENSR</u>
HAST	A2	Biased HAST	130C/85%RH	96 Hours				-				-	3/231/0	-
UHAST	A3	Autoclave	121C/15psig	96 Hours									3/231/0	
UHAST	A3	Unbiased HAST	130C/85%RH	96 Hours							3/231/0			
тс	A4	Temperature Oycle	-65C/150C	500 Cycles				-			3/231/0	3/231/0	3/231/0	
HTSL	A6	High Temperature Storage Life	150C	1000 Hours			-	-	-	-	3/231/0	3/231/0	3/231/0	
HTOL	81	Life Test	135C	635 Hours				-		3/231/0				
ESD	E2	ESD CDM	-	1000 Volts				-				-		1/3/0
ESD	E2	ESD CDM	-	250 Volts	1/3/0	1/3/0	1/3/0	1/3/0	1/3/0			-		
ESD	E2	ESD HBM		1000 Volts	1/3/0			-			-			-
ESD	E2	ESD HBM (Bus Pins)	-	15000 Volts	1/3/0	-	-	1/3/0	-	-	-	-		1/3/0
ESD	E2	ESD HBM	-	4000 Volts				-			-	-		1/3/0
LU	E4	Latch-Up	Per JESD78				-				-	-		1/3/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	-	1/30/0	-	-	-	-	-	-	1/30/0

QBS: Qual By Similarity
Qual Device SN65C1168EPWR is qualified at MSL1 260C
Qual Device SN65C1168ENSR is qualified at MSL1 260C
Qual Device SN75C1167DBR is qualified at MSL1 260C

Qual Device SN65C1167EPWR is qualified at MSL1 260C

Qual Device SN75C1168DBR is qualified at MSL1 260C

Qual Device SN65C1167ENSR is qualified at MSL1 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2206-031

#### **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN75ALS1177N</u>	Qual Device: <u>SN75ALS1178N</u>	QBS Reference (Package): <u>TLC339IN</u>	QBS Reference (Process): <u>TPS51217DSCR</u>	QBS Reference (Product): <u>SN65C1167ENSR</u>
UHAST	A3	Autoclave	121C/15psig	96 Hours	-	-	3/231/0	-	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	3/231/0	-	-
HTSL	A6	High Temperature Storage Life	170C	420 Hours	-	-	3/231/0	-	-
HTOL	B1	Life Test	135C	635 Hours	-	-	-	3/231/0	-
SD	C3	PB-Free Solderability	8 Hours Steam Age	-	-	-	3/66/0	-	-
ESD	E2	ESD CDM	-	1000 Volts	-	-	-	-	1/3/0
ESD	E2	ESD CDM	-	250 Volts	1/3/0	1/3/0	-	-	-
ESD	E2	ESD HBM	-	1000 Volts	-	1/3/0	-	-	-
ESD	E2	ESD HBM (Bus Pins)	-	15000 Volts	-	-	-	-	1/3/0
ESD	E2	ESD HBM	-	4000 Volts	-	-	-	-	1/3/0
LU	E4	Latch-Up	Per JESD78	-	-	1/3/0	-	-	1/3/0

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN75ALS1177N</u>	Qual Device: <u>SN75ALS1178N</u>	QBS Reference (Package): <u>TLC339IN</u>	QBS Reference (Process): <u>TPS51217DSCR</u>	QBS Reference (Product): <u>SN65C1167ENSR</u>
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	1/30/0	-	-	1/30/0

QBS: Qual By Similarity

Qual Device SN75ALS1177N is qualified at NOT CLASSIFIED NOT CLASSIFIED

Qual Device SN75ALS1178N is qualified at NOT CLASSIFIED NOT CLASSIFIED

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2206-032

#### **Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN751177NSR</u>	QBS Reference (Process): <u>TPS51217DSCR</u>	QBS Reference (Package): <u>SN74LVC8T245NSR</u>	QBS Reference (Product): <u>SN65C1167ENSR</u>
тс	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	3/231/0	-
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	-	-	3/231/0	-
HTOL	B1	Life Test	135C	635 Hours	-	3/231/0	-	-
ESD	E2	ESD CDM	-	1000 Volts	-	-	-	1/3/0
ESD	E2	ESD CDM	-	250 Volts	1/3/0	-	-	-
ESD	E2	ESD HBM	-	1000 Volts	1/3/0	-	-	-
ESD	E2	ESD HBM (Bus Pins)	-	15000 Volts	-	-	-	1/3/0
ESD	E2	ESD HBM	-	4000 Volts	-	-	-	1/3/0
LU	E4	Latch-Up	Per JESD78	-	1/3/0	-	-	1/3/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	-	-	1/30/0

• QBS: Qual By Similarity

• Qual Device SN751177NSR is qualified at MSL1 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

• The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

• The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2206-029

#### Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN75ALS1177NSR</u>	Qual Device: <u>SN75ALS1178NSR</u>	QBS Reference (Package): <u>SN75ALS1177NS</u>	QBS Reference (Process): <u>TPS51217DSCR</u>	QBS Reference (Product): <u>SN65C1167ENSR</u>
UHAST	A3	Autoclave	121C/15psig	96 Hours	-	-	3/231/0	-	-
тс	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	3/231/0	-	-
HTOL	B1	Life Test	135C	635 Hours	-	-	-	3/231/0	-
ESD	E2	ESD CDM	-	1000 Volts	-	-	-	-	1/3/0
ESD	E2	ESD CDM	-	250 Volts	1/3/0	1/3/0	-	-	-
ESD	E2	ESD HBM	-	1000 Volts	1/3/0	-	-	-	1/3/0
ESD	E2	ESD HBM (Bus Pins)	-	15000 Volts	-	-	-	-	1/3/0
ESD	E2	ESD HBM	-	4000 Volts	-	-	-	-	1/3/0
LU	E4	Latch-Up	Per JESD78	-	1/3/0	-	-	-	1/3/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	1/30/0	-	-	1/30/0

QBS: Qual By Similarity

Qual Device SN75ALS1177NSR is qualified at MSL1 260C

Qual Device SN75ALS1178NSR is qualified at MSL1 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

• The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

• The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2206-033

#### Qualification Results

#### Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN751178NSR</u>	QBS Reference (Process): <u>TPS51217DSCR</u>	QBS Reference (Package): <u>SN74LVC8T245NSR</u>	QBS Reference (Product): <u>SN65C1167ENSR</u>
тс	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	3/231/0	-
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	-	-	3/231/0	-
HTOL	B1	Life Test	135C	635 Hours	-	3/231/0	-	-
WBS	C1	Ball Shear	76 balls, 3 units min	Wires	1/76/0	-	-	-
WBP	C2	Bond Pull	76 Wires, 3 units min	Wires	1/76/0	-	-	-
ESD	E2	ESD CDM	-	1000 Volts	1/3/0	-	-	1/3/0
ESD	E2	ESD HBM (Bus Pins)	-	15000 Volts	-	-	-	1/3/0
ESD	E2	ESD HBM	-	2000 Volts	1/3/0	-	-	-
ESD	E2	ESD HBM	-	4000 Volts	-	-	-	1/3/0
LU	E4	Latch-Up	Per JESD78	-	1/3/0	-	-	1/3/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	-	-	1/30/0

QBS: Qual By Similarity

Qual Device SN751178NSR is qualified at MSL1 260C

· Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

• The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

• The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2306-021

#### Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN65C1167ERGYR</u>	Qual Device: <u>SN65C1168ERGYR</u>	QBS Reference (Process): <u>TPS51217DSCR</u>	QBS Reference (Package): <u>TS3A5017QRGYRQ1</u>	QBS Reference (Product): <u>SN65C1167ENSR</u>
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	-	-	3/231/0	-
UHAST	A3	Autoclave	121C/15psig	96 Hours	-	-	-	3/231/0	-
тс	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	-	3/231/0	-
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	-	-	-	3/135/0	-
HTOL	B1	Life Test	135C	635 Hours	-	-	3/231/0	-	-
SD	C3	PB Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes)	-	-	-	-	1/15/0	-
SD	C3	PB-Free Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes)	-	-	-	-	1/15/0	-

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN65C1167ERGYR</u>	Qual Device: <u>SN65C1168ERGYR</u>	QBS Reference (Process): <u>TPS51217DSCR</u>	QBS Reference (Package): <u>TS3A5017QRGYRQ1</u>	QBS Reference (Product): <u>SN65C1167ENSR</u>
PD	C4	Physical Dimensions	Cpk>1.67	-	-	-	-	3/30/0	-
ESD	E2	ESD CDM	-	250 Volts	1/3/0	1/3/0	-	-	-
ESD	E2	ESD HBM (Bus Pins)	-	15000 Volts	-	-	-	-	1/3/0
ESD	E2	ESD HBM	-	4000 Volts	-	-	-	-	1/3/0
LU	E4	Latch-Up	Per JESD78	-	1/3/0	1/3/0	-	-	1/3/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	1/30/0	-	-	1/30/0

• QBS: Qual By Similarity

Qual Device SN65C1167ERGYR is qualified at MSL2 260C

Qual Device SN65C1168ERGYR is qualified at MSL2 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

• The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2206-030

#### Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: <u>SN65C1167ENSR</u>	QBS Reference (Package): <u>TL092CPS</u>	QBS Reference (Package): <u>SN75ALS1177NS</u>	QBS Reference (Process): <u>TPS51217DSCR</u>
UHAST	A3	Autoclave	121C/15psig	96 Hours	-	3/230/0	3/231/0	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	3/231/0	3/231/0	-
HTSL	A6	High Temperature Storage Life	170C	420 Hours	-	3/231/0	-	-
HTOL	B1	Life Test	135C	635 Hours	-	-	-	3/231/0
ESD	E2	ESD CDM	-	1000 Volts	1/3/0	-	-	-
ESD	E2	ESD HBM (Bus Pins)	-	15000 Volts	1/3/0	-	-	-
ESD	E2	ESD HBM	-	4000 Volts	1/3/0	-	-	-
LU	E4	Latch-Up	Per JESD78	-	1/3/0	-	-	-
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	-	-	-

QBS: Qual By Similarity

Qual Device SN65C1167ENSR is qualified at MSL1 260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

TI Qualification ID: R-CHG-2308-042

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (<u>www.ti.com/legal/termsofsale.html</u>) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.